## INTEGRATED CIRCUITS

## DATA SHEET

# **74ALS74A**Dual D-type flip-flop with set and reset

Product specification

1996 Jul 01

IC05 Data Handbook





## Dual D-type flip-flop with set and reset

**74ALS74A** 

#### DESCRIPTION

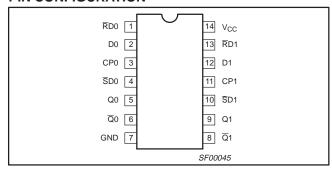
The 74ALS74 is a dual positive edge-triggered D-type flip-flop featuring individual data, clock, set, and reset inputs; also true and complementary outputs. Set (\$\overline{S}D\$) and reset (\$\overline{R}D\$) are asynchronous active-Low inputs and operate independently of the clock input. When set and reset are inactive (High), data at the D input is transferred to the Q and \$\overline{Q}\$ outputs on the Low-to-High transition of the clock. Data must be stable just one setup time prior to the Low-to-High transition of the clock for predictable operation. Clock triggering occurs at a voltage level and is not directly related to the transition time of the positive-going pulse. Following the hold time interval, data at the D input may be changed without affecting the levels of the output.

TYPE	TYPICAL f <sub>MAX</sub>	TYPICAL SUPPLY CURRENT (TOTAL)
74ALS74A	150MHz	3.0mA

#### ORDERING INFORMATION

	ORDER CODE	DRAWING NUMBER	
DESCRIPTION	COMMERCIAL RANGE $V_{CC}$ = 5V ±10%, $T_{amb}$ = 0°C to +70°C		
14-pin plastic DIP	74ALS74AN	SOT27-1	
14-pin plastic SO	74ALS74AD	SOT108-1	
14-pin plastic SSOP Type II	74ALS74ADB	SOT337-1	

## **PIN CONFIGURATION**

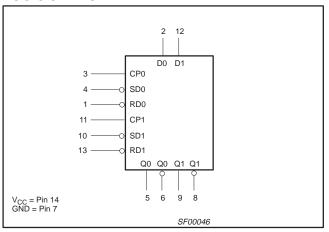


## INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

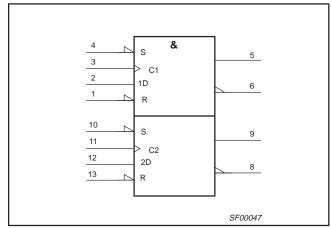
PINS	DESCRIPTION	74ALS (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
D0, D1	Data inputs	1.0/2.0	20μA/0.2mA
CP0, CP1	Clock inputs (active rising edge)	1.0/2.0	20μA/0.2mA
SD0, SD1	Set inputs (active-Low)	2.0/4.0	40μA/0.4mA
RD0, RD1	Reset inputs (active-Low)	2.0/4.0	40μA/0.4mA
Q0, Q1, Q0, Q1	Data outputs	20/80	0.4mA/8mA

NOTE: One (1.0) ALS unit load is defined as: 20µA in the High state and 0.1mA in the Low state.

## **LOGIC SYMBOL**



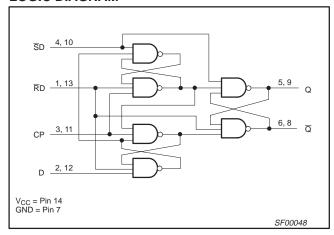
## **IEC/IEEE SYMBOL**



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#### **LOGIC DIAGRAM**



#### **FUNCTION TABLE**

	INPUTS			OUT	PUTS	OPERATING
SD	RD	СР	D	Q	Q	MODE
L	Н	Х	Х	Н	L	Asynchronous set
Н	L	Х	Х	L	Н	Asynchronous reset
L	L	Х	Х	Н	Н	Undetermined*
Н	Н	1	h	Н	L	Load "1"
Н	Н	1	I	L	Н	Load "0"
Н	Н	1	Х	NC	NC	Hold

H = High voltage level

High state must be present one setup time prior to

Low-to-High clock transition

Low voltage level

= Low state must be present one setup time prior to

Low-to-High clock transition

NC= No change from the previous setup

= Low-to-High clock transition

X = Don't care

↑ = Low-to-Hig

↑ = Not Low-to

\* = Both output Not Low-to-High clock transition

Both outputs will be High while both  $\overline{SD}$  and  $\overline{RD}$  are Low, but the output states are unpredictable if  $\overline{\mathsf{SD}}$  and  $\overline{\mathsf{RD}}$  go

High simultaneously

## **ABSOLUTE MAXIMUM RATINGS**

(Operation beyond the limit set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V <sub>CC</sub>	Supply voltage	-0.5 to +7.0	V
V <sub>IN</sub>	Input voltage	-0.5 to +7.0	V
I <sub>IN</sub>	Input current	-30 to +5	mA
V <sub>OUT</sub>	Voltage applied to output in High output state	–0.5 to V <sub>CC</sub>	V
lout	Current applied to output in Low output state	16	mA
T <sub>amb</sub>	Operating free-air temperature range	0 to +70	°C
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C

## RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		UNIT			
STWBOL	PARAMETER	MIN	NOM	MAX	ONII	
V <sub>CC</sub>	Supply voltage	4.5	5.0	5.5	V	
V <sub>IH</sub>	High-level input voltage	2.0			V	
V <sub>IL</sub>	Low-level input voltage			0.8	V	
I <sub>lk</sub>	Input clamp current			-18	mA	
I <sub>OH</sub>	High-level output current			-0.4	mA	
I <sub>OL</sub>	Low-level output current			8	mA	
T <sub>amb</sub>	Operating free-air temperature range	0		+70	°C	

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#### DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

CVMDOL	DADAMETED		TEST CONDITIONS		LIMITS			шит
SYMBOL	PARAMETER		TEST CONDITIO	TEST CONDITIONS <sup>1</sup>		TYP <sup>2</sup>	MAX	UNIT
V <sub>OH</sub>	High-level output voltage	High-level output voltage		I <sub>OH</sub> = MAX	V <sub>CC</sub> – 2			V
M	Low lovel output voltage		V <sub>CC</sub> = MIN, V <sub>IL</sub> = MAX,	$I_{OL} = 4mA$		0.25	0.40	V
V <sub>OL</sub>	Low-level output voltage		V <sub>IH</sub> = MIN	I <sub>OL</sub> = 8mA		0.35	0.50	V
$V_{IK}$	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$			-0.73	-1.5	V
	, Input current at maximum input	Dn, CPn	V MAY V 7.0V				0.1	mA
11	voltage		$V_{CC} = MAX, V_I = 7.0V$			0.2	mA	
	High levelingut compat	Dn, CPn	V MAY V 0.7V				20	μΑ
1 <sub>IH</sub>	High-level input current	SDn, RDn	$V_{CC} = MAX, V_I = 2.7V$				40	μΑ
	I <sub>IL</sub> Low–level input current		V				-0.2	mA
IIL			$V_{CC} = MAX, V_I = 0.4V$				-0.4	mA
I <sub>O</sub>	Output current <sup>3</sup>		$V_{CC} = MAX, V_O = 2.25V$		-30		-112	mA
Icc	Supply current (total) <sup>4</sup>		V <sub>CC</sub> = MAX			3.0	4.0	mA

#### NOTES:

- 1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- 2. All typical values are at  $V_{CC} = 5V$ ,  $T_{amb} = 25^{\circ}C$ .
- The output conditions have been chosen to produce a current that closely approximates one half of the true short–circuit output current, I<sub>OS</sub>.
   Measure I<sub>CC</sub> with the Dn, CPn, and SDn grounded, then with Dn, CPn, and RDn grounded.

## **AC ELECTRICAL CHARACTERISTICS**

			LIM	UNIT	
SYMBOL	PARAMETER	TEST CONDITION	T <sub>amb</sub> = 0°0 V <sub>CC</sub> = +5. C <sub>L</sub> = 50pF,		
			MIN	MAX	
f <sub>max</sub>	Maximum clock frequency	Waveform 1	80		MHz
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay CPn to Qn or Qn	Waveform 1	3.0 3.0	14.0 14.0	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay $\overline{S}$ Dn or $\overline{R}$ D to $\overline{Q}$ n	Waveform 2, 3	1.0 3.0	8.0 10.0	ns

#### **AC SETUP REQUIREMENTS**

			LIN		
SYMBOL	PARAMETER	TEST CONDITION	T <sub>amb</sub> = 0°( V <sub>CC</sub> = +5. C <sub>L</sub> = 50pF,	C to +70°C .0V ± 10% R <sub>L</sub> = 500Ω	UNIT
			MIN	MAX	
t <sub>su</sub> (H) t <sub>su</sub> (L)	Setup time, High or Low Dn to CPn	Waveform 1	6.0 6.0		ns
t <sub>h</sub> (H) t <sub>h</sub> (L)	Hold time, High or Low Dn to CPn	Waveform 1	0.0 0.0		ns
t <sub>w</sub> (H) t <sub>w</sub> (L)	CPn Pulse width High or Low	Waveform 1	6.0 6.0		ns
t <sub>w</sub> (L)	SDn or RDn Pulse width, Low	Waveform 2, 3	6.0		ns
t <sub>rec</sub>	Recovery time, SDn or RDn to CPn	Waveform 2, 3	6.0		ns

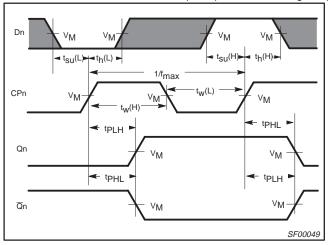
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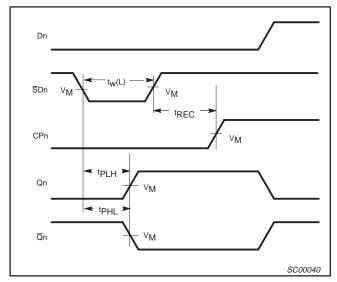
#### **AC WAVEFORMS**

For all waveforms,  $V_M = 1.3V$ .

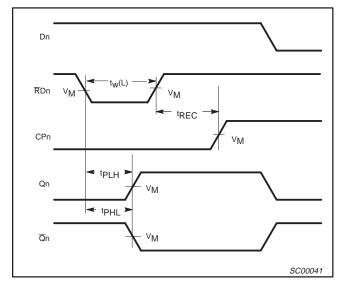
The shaded areas indicate when the input is permitted to change for predictable output performance.



Waveform 1. Propagation Delay for Data to Output, Data Setup and Hold Times, Clock Width, and Maximum Clock Frequency



Waveform 2. Propagation Delay for Set to Output, Set Pulse Width and Recovery Time for Set to Clock



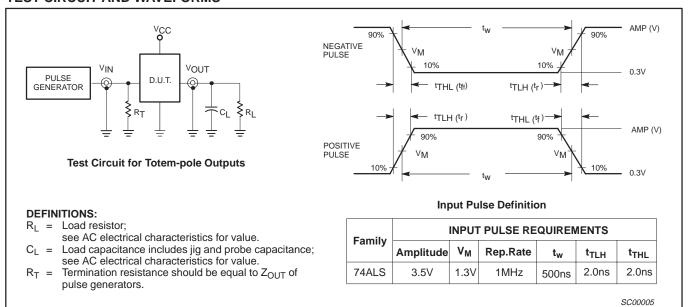
Waveform 3. Propagation Delay for Reset to Output, Reset Pulse Width and Recovery Time for Reset to Clock

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## **TEST CIRCUIT AND WAVEFORMS**



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DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1

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Dual D-type flip-flop with set and reset

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SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

## Dual D-type flip-flop with set and reset

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**NOTES** 

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